

AMPMODU | AMPMODU Headers

TE Internal #: 5-102202-2 PCB Mount Header, Vertical, Board-to-Board, 5 Position, 2.54 mm [. 1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

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PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 5

Number of Rows: 1

Features

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Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	5
Number of Rows	1
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 Vrms
Body Features	

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Housing Temperature Rating	Standard
Usage Conditions	
PCB Thickness (Recommended)	1.4 mm[.055 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Dimensions	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Housing Features	
Connector Mounting Type	Board Mount
PCB Mount Alignment	Without
PCB Mount Retention	Without
Mating Alignment Type	Polarization
Mating Alignment	With
Mechanical Attachment	
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Post & Tail Length	3.3 mm[.13 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Features	
	J A
Contact Type Contact Current Rating (Max)	3 A
Contact Mating Area Plating Material Thickness	.381 μm[15 μin] Pin
Contact Mating Area Plating Material Thickness	Gold
Contact Mating Area Plating Material	Brass
PCB Contact Termination Area Plating Material	Tin
Contact Underplating Material	Nickel
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Mating Square Post Dimension	.64 mm[.025 in]
Contact Features	
Primary Product Color	Black

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Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Agency/Standard	CSA
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	34
Packaging Type Product Compliance	Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
Product Compliance	Compliant
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC	Compliant Compliant
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC China RoHS 2 Directive MIIT Order No 32, 2016	CompliantCompliantMo Restricted Materials Above ThresholdCurrent ECHA Candidate List: JUNE 2023 (235)Candidate List Declared Against: JUNE 2023 (235)

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Compatible Parts



Also in the Series AMPMODU Headers





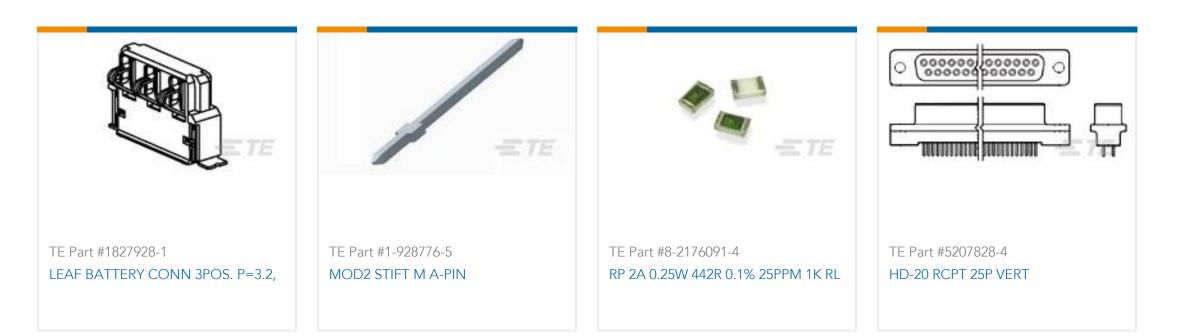


Customers Also Bought



PCB Mount Header, Vertical, Board-to-Board, 5 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers







Documents

Product Drawings 05 MODII HDR SRST SHRD LF

English

CAD Files 3D PDF

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English

Customer View Model ENG_CVM_5-102202-2_P.3d_igs.zip

English

Customer View Model

ENG_CVM_5-102202-2_P.3d_stp.zip

English

Customer View Model

ENG_CVM_5-102202-2_P.2d_dxf.zip

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Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English

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